## IFIC status report for the TB2025

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# Irles A 24th April 2025

#### Inventory – available at IFIC



- Sensors characterized-
  - 20 from TAU are in the dry cabinet OK
  - In the process of been cleaned. ongoing
- **○** Adhesive **○**K
  - Different types of conductive glue + non-conductive
- **⊳**CF
  - ~15 low quality CF (made by ClipCarbono being used for tests)
  - 20 better quality CF (made by ClipCarbono but machined by WorkShape (FR) OK



#### Inventory – available at IFIC

### IFIC INSTITUT DE FÍSICA CORPUSCULAR

- **▷** Signal Fanouts
  - 10 FO kaptons with connectors: Not OK (but 20 more are in production by TAU)
  - + 2 in Krakow
  - + 2 used for CF glue tests
  - +5 being used for glueing/curing/deformation studies tests today and tomorrow

#### **►**HV kaptons Fanouts

- 15 HV kaptons with connectors: Almost OK (but 20 more are in production by TAU)
- 5 being used in tests

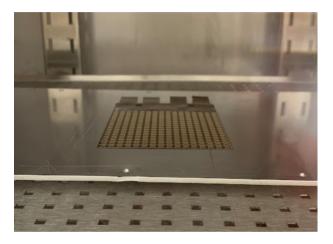




#### Ongoing tests



Last week tests (CF+real Fanout using siliconne glue)





before curing

During curing

- This week we are validating the procedure of glueing the CF only at the end
  - To avoid deformations in the oven



# Irles A., 24th April 2025

### (real) Material budget

IFIC

**○ CF: 225um +-10um** 

Siliconne glue: 100um (+-?)

**▶ Fanout:** 115-135um

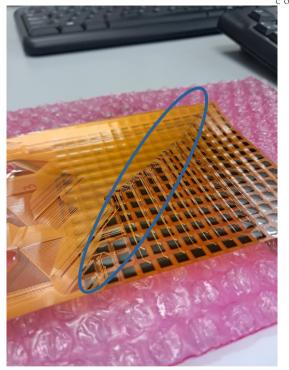
• depends on the "accumulation" of routing lines

Sensor: 320um

**► HV kapton:** 55-60um

Total (no conductive glue) = 805-850

Total (with two layers of conductive glue) = 905-950um



#### Notes:

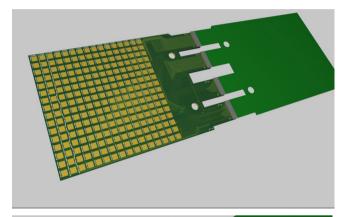
- the siliconne layer thickness cannot be improved with "manual" pressure because we do this step at the end, with sensors attached
- Thin double tape can be a possibility for replacement of the siliconne (under study)

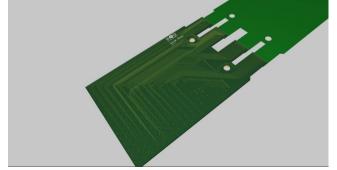


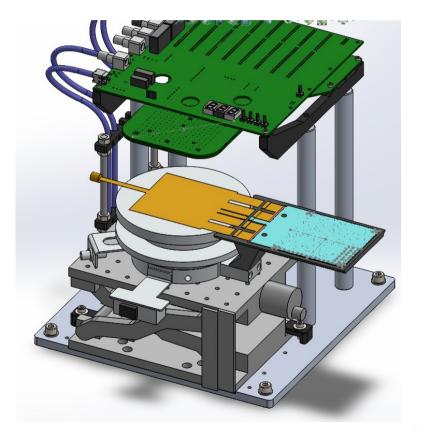
#### **Testing the connectivity**



- We have the gerbers from Yan but still we had no chance to discuss it with our electronics service (everyone is in holidays)
  - I will make this my priority next week...









#### **How any CSIS?**



rom IFIC we hope that we can stick to 10 layers (i.e. 20 CSIS) agreed originally because:

- we don't have the material for more (and part of the material for the 20 is still to come). This includes, for example, the CF sheets.
- some of the items still do not meet the tight mechanical requirements that we initially planned for the final detector (for instance the CF or the separation between the CSIS).
- for the sake of the beam test running, we are postponing some R&D initiatives that we hope will benefit the **next iteration of CSIS production/design** and make it through the final design. For example: replacing the CF by a thicker fanout
- How to test the mounted CSIS? is still not claryfied. I rather do a small production now (~5 CSIS and wait until this is claryfied for the final production)

I hope that **20 CSIS** is already a good number that allow us to extract physics measurements and at the same time allow us to keep untouched all the remaining **90 sensors that are in our cabinets (70 from TAU and 20 from IFIC).** 

